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# RENESAS SEMICONDUCTOR RELIABILITY REPORT

GROUP : RA8M1

DEVICE : R7FA8M1XXX

APPLICATION: Consumer / Industry

Quality Assurance Div. Renesas Electronics Corporation



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### Table. Reliability test results (QFP)

Test Items	Reference	Test Conditions	Test Conditions  Results Failure/Size	
High Temperature Operating Life (HTOL)	JESD22-A108	Tj=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 $℃$ to 150 $ℂ$ , 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Solderability (SD)	J-STD-002 245 °C, 5 s, Solder coverage ≥95 %		0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

<sup>\*1)</sup> With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.



## Table. Reliability test results (BGA)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Tj=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	C, RH=85 %, Vccmax, 1000 hrs 0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-55 $^{\circ}$ C to 125 $^{\circ}$ C , 500 cycles 0/22		
Latch-Up (LU)	JESD78 Pulse Current Injection, I=+/-150 mA		0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

<sup>\*1)</sup> With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.

The failure rate of the device in an actual use condition can be estimated by the below procedure.

### •Equation for the failure rate estimation (λ)

$$\lambda = \lambda b \times \pi T$$
 (FIT)

①Unique failure rate (λb)

$$\lambda b = 0.08 \text{ FIT}$$

Unique failure rate at Ta=55 ℃ using 60 % confidence level.

②Temperature term ( $\pi$ T)

$$\pi T = \exp\{11600 \times Ea \times (1/(273+55)-1/(273+Ta))\}$$

Ea: Activation energy (eV)
Ta: Ambient temperature (℃)

$\pi$ T simplified chart as Ea=0.7 eV												
Ta (℃)	40	50	55	60	65	70	75	80	85	90	100	110
πТ	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

### ·MTTF ( Mean Time To Failure )

$$MTTF = 1/\lambda$$



### Reference about Renesas package code

Package type	Package code *1	
Lead type plastic package	QFP	PxQP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG

<sup>\*1.</sup> First four digit

### Table. Product list

	e. Product				_		
No	Group	Product part number	Package code	No	Group	Product part number	Package code
1	RA8M1	R7FA8M1AFECBD	PLBG0224G*	51			
2	RA8M1	R7FA8M1AHECBD	PLBG0224G*	52			
3	RA8M1	R7FA8M1AFECFB	PLQP0144K*	53			
4	RA8M1	R7FA8M1AHECFB	PLQP0144K*	54			
5	RA8M1	R7FA8M1AFECFC	PLQP0176K*	55			
6	RA8M1	R7FA8M1AHECFC	PLQP0176K*	56			
7	RA8M1	R7FA8M1AFECFP	PLQP0100K*	57			
8	RA8M1	R7FA8M1AHECFP	PLQP0100K*	58			
9				59			
10				60			
11				61			
12				62			
13				63			
14				64			
15				65			
16				66			
17	1			67	1		
18	+			68	1		
19				69			
20				70			
21				71		+	
22	1			72	+		
23		_		73			
23 24				74			
25				75			
26				76			
27				77			
28	-			78	-		
29	-			79	-		
30				80			
31				81			
32				82			
33				83			
34				84			
35				85			
36				86			
37				87			
38				88			
39				89			
40				90			
41				91			
42				92			
43				93			
44				94			
45				95			
46				96			
47				97			
48				98	1		
49	+			99	1	<del> </del>	
50	+			100	+		
JU			1	100	1		1